

#6/a

PATENT

2/4/03

Schmitz

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**Applicants:** Toshimichi Kurihara, et al.**Examiner:** Nema O. Berezny**Serial No.:** 09/942,445**Unit:** 2813**Filed:** Aug. 30, 2001**Docket:** 14872**For:** SEMICONDUCTOR DEVICE AND
MANUFACTURING METHOD THEREOF**Dated:** January 24, 2003Assistant Commissioner for Patents
Washington, DC 20231RESPONSE

Sir:

Responsive to the Office Action of October 24, 2002, please amend this patent
application as follows.

IN THE CLAIMSPlease amend claims 1, 2 and 6 as follows.

1.(Amended) A semiconductor device comprising:

a radiating plate;

a semiconductor chip bonded onto the radiating plate;

a resin wall bonded at the lower end to the radiating plate to surround the

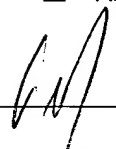
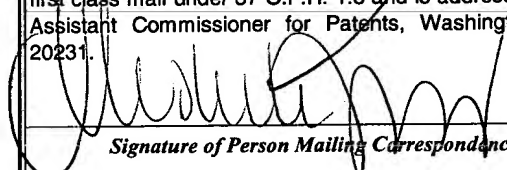
CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service a
first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, DC 20231 on
January 24, 2003.

Dated: January 24, 2003

Michelle Mustafa

2813

AMENDMENT TRANSMITTAL LETTER (Large Entity)				Docket No. 14872	
Applicant(s): Toshimichi Kurahara, et al.					
Serial No. 09/942,445		Filing Date 8/30/01		Examiner Nema O. Berezny	
				Group Art Unit 2813	
Invention: SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF					
<u>TO THE ASSISTANT COMMISSIONER FOR PATENTS:</u>					
Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.					
CLAIMS AS AMENDED					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	25 -	21 =	4 x	\$18.00	\$72.00
INDEP. CLAIMS	4 -	4 =	0 x	\$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$72.00
<div><input type="checkbox"/> No additional fee is required for amendment.</div> <div><input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of _____ A duplicate copy of this sheet is enclosed.</div> <div><input checked="" type="checkbox"/> A check in the amount of \$72.00 to cover the filing fee is enclosed.</div> <div><input checked="" type="checkbox"/> The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-1013/SSMP A duplicate copy of this sheet is enclosed.<div><input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16.</div><div><input type="checkbox"/> Any patent application processing fees under 37 CFR 1.17.</div></div>					
<div> _____ Signature</div> <div>Paul J. Esatto, Jr. Registration No. 30,749 Scully, Scott, Murphy & Presser 400 Garden City Plaza Garden City, New York 11530 (516) 742-4343</div>			Dated: January 24, 2003		
CC:			<div>I certify that this document and fee is being deposited on 1/24/03 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.</div> <div> _____ Signature of Person Mailing Correspondence</div> <div>Mishelle Mustafa _____ Typed or Printed Name of Person Mailing Correspondence</div>		

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